Unit: mm

TOSHIBA Field Effect Transistor Silicon N Channel MOS Type ( $\pi$ -MOSIV)

# 2SK3265

# Chopper Regulators DC-DC Converter and Motor Drive Applications

• Low drain–source ON resistance :  $RDS(ON) = 0.72 \Omega \text{ (typ.)}$ 

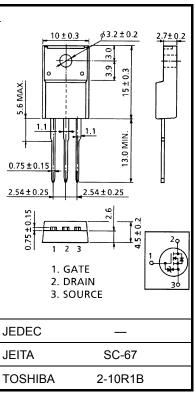
• High forward transfer admittance  $: |Y_{fs}| = 7.0 \text{ S (typ.)}$ 

• Low leakage current :  $I_{DSS} = 100 \mu A \text{ (max) (V}_{DS} = 700 \text{ V)}$ 

• Enhancement mode  $: V_{th} = 2.0 \text{ to } 4.0 \text{ V (VDS} = 10 \text{ V, ID} = 1 \text{ mA)}$ 

#### **Absolute Maximum Ratings (Ta = 25°C)**

Characteris	stics	Symbol	Rating	Unit
Drain-source voltage		$V_{DSS}$	700	V
Drain-gate voltage (Ro	<sub>SS</sub> = 20 kΩ)	$V_{DGR}$	700	V
Gate-source voltage		V <sub>GSS</sub>	±30	V
Drain current	DC (Note 1)	I <sub>D</sub>	10	Α
Diain cuitent	Pulse (Note 1)	I <sub>DP</sub>	30	Α
Drain power dissipation	ı	P <sub>D</sub>	45	W
Single pulse avalanche energy (Note 2)		E <sub>AS</sub>	420	mJ
Avalanche current		I <sub>AR</sub>	10	Α
Repetitive avalanche energy (Note 3)		E <sub>AR</sub>	4.5	mJ
Channel temperature		T <sub>ch</sub>	150	°C
Storage temperature range		T <sub>stg</sub>	-55 to 150	°C



Weight: 1.9 g (typ.)

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

#### **Thermal Characteristics**

Characteristics	Symbol	Max	Unit
Thermal resistance, channel to case	R <sub>th (ch-c)</sub>	2.78	°C / W
Thermal resistance, channel to ambient	R <sub>th (ch-a)</sub>	62.5	°C/W

Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2:  $V_{DD} = 90 \text{ V}$ ,  $T_{ch} = 25^{\circ}\text{C}$  (initial), L = 7.5 mH,  $R_G = 25 \Omega$ ,  $I_{AR} = 10 \text{ A}$ 

Note 3: Repetitive rating pulse width limited by maximum channel temperature.

This transistor is an electrostatic-sensitive device.

Please handle with caution.



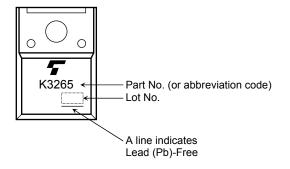
## **Electrical Characteristics (Ta = 25°C)**

Charac	cteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cu	ırrent	I <sub>GSS</sub>	V <sub>GS</sub> = ±25 V, V <sub>DS</sub> = 0 V	_	_	±10	μА
Gate-source bre	eakdown voltage	V (BR) GSS	$I_G = \pm 10 \mu A, V_{DS} = 0 V$	±30	_	_	V
Drain cut-off cu	rrent	I <sub>DSS</sub>	V <sub>DS</sub> = 700 V, V <sub>GS</sub> = 0 V	_	_	100	μА
Drain-source br	eakdown voltage	V (BR) DSS	I <sub>D</sub> = 10 mA, V <sub>GS</sub> = 0 V	700	_	_	V
Gate threshold v	/oltage	$V_{th}$	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 1 mA	2.0	_	4.0	V
Drain-source O	N resistance	R <sub>DS</sub> (ON)	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 5 A	_	0.72	1.0	Ω
Forward transfer	r admittance	Y <sub>fs</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 5 A	4.0	7.0	_	S
Input capacitano	ce	C <sub>iss</sub>		_	1700	_	
Reverse transfe	r capacitance	C <sub>rss</sub>	V <sub>DS</sub> = 25 V, V <sub>GS</sub> = 0 V, f = 1 MHz	_	40	_	pF
Output capacitance		Coss		_	200	_	
Switching time	Rise time	tr	$V_{GS}$ $V_{OUT}$ $V_{OUT}$ $V_{OUT}$ $V_{OUT}$ $V_{OUT}$ $V_{OUT}$ $V_{OUT}$ $V_{OUT}$ $V_{OUT}$	_	40	_	
	Turn-on time	t <sub>on</sub>			72		ne
	Fall time	t <sub>f</sub>		_	42	_	ns
	Turn-off time	t <sub>off</sub>	Duty $\leq 1\%$ , $t_{\mathbf{W}} = 10 \mu s$	_	145	_	
Total gate charge (Gate-source plus gate-drain)		Qg	V <sub>DD</sub> ≈ 400 V, V <sub>GS</sub> = 10 V, I <sub>D</sub> = 10 A	_	53	_	
Gate-source charge		Q <sub>gs</sub>		_	25	_	nC
Gate-drain ("miller") charge		Q <sub>gd</sub>			28		

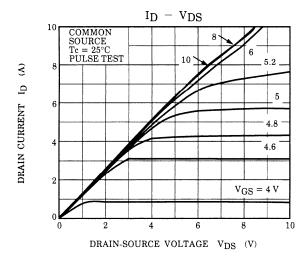
## Source-Drain Ratings and Characteristics (Ta = 25°C)

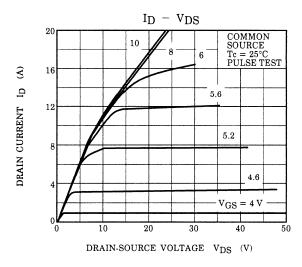
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)	I <sub>DR</sub>	_	_	_	10	Α
Pulse drain reverse current (Note 1)	I <sub>DRP</sub>	_	_	_	30	Α
Forward voltage (diode)	V <sub>DSF</sub>	I <sub>DR</sub> = 10 A, V <sub>GS</sub> = 0 V	_	_	-1.9	V
Reverse recovery time	t <sub>rr</sub>	I <sub>DR</sub> = 10 A, V <sub>GS</sub> = 0 V		1400	_	ns
Reverse recovery charge	Q <sub>rr</sub>	dl <sub>DR</sub> / dt = 100 A / μs	1	17.5	1	μС

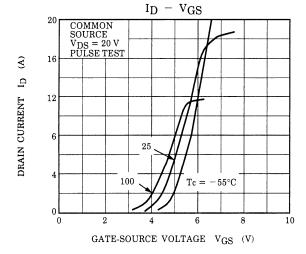
## Marking

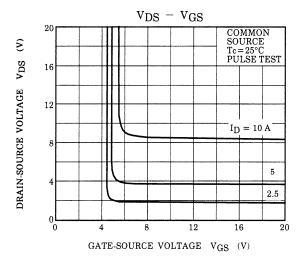


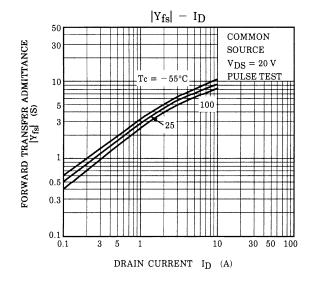
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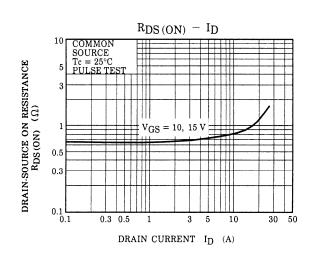


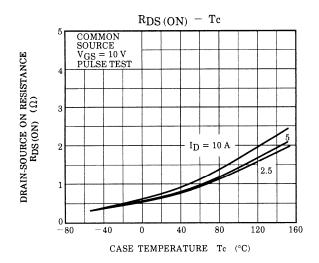


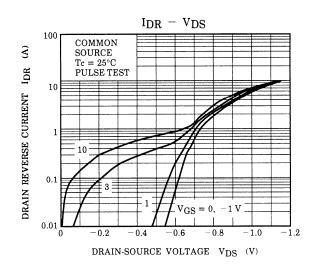


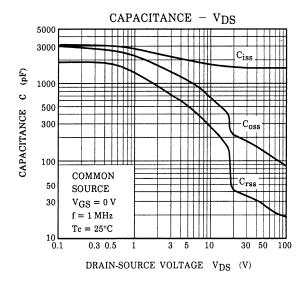


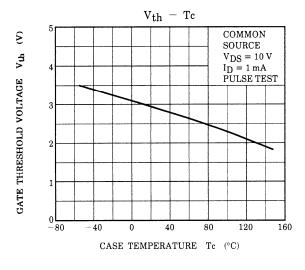


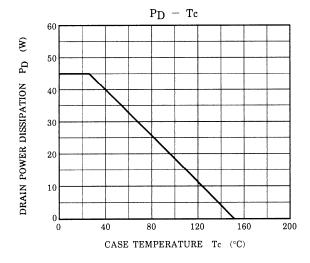


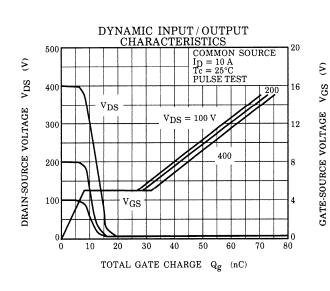




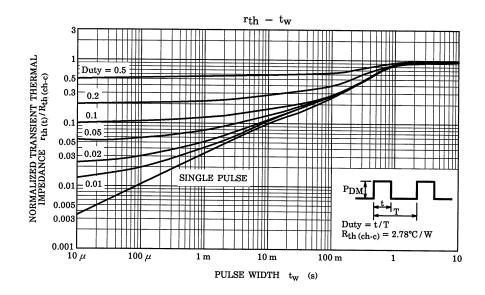


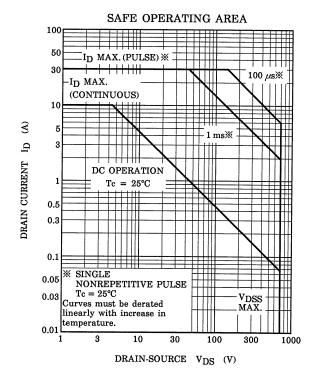


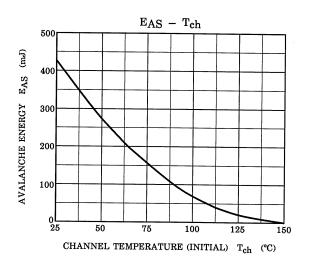


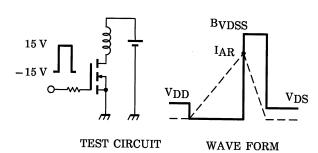


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$$\begin{aligned} R_G &= 25~\Omega \\ V_{DD} &= 90~V,~L = 7.5~mH \end{aligned} \qquad E_{AS} &= \frac{1}{2} \cdot L \cdot I^2 \cdot \left( \frac{B_{VDSS}}{B_{VDSS} - V_{DD}} \right) \end{aligned}$$

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20070701-EN GENERAL

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